

BB02-GZ :- 2.00mm x 2.00mm (0.079" x 0.079") SOCKET, SMD, DUAL ROW - 06 to 70 CONTACTS, DUAL ENTRY

SPECIFICATIONS

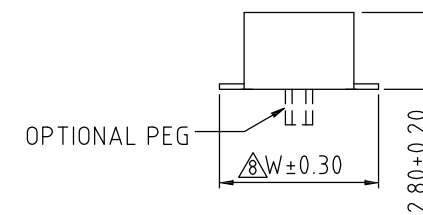
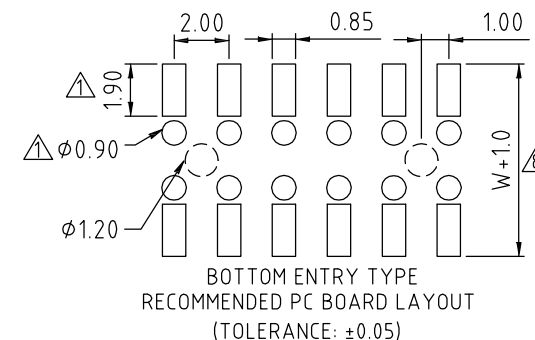
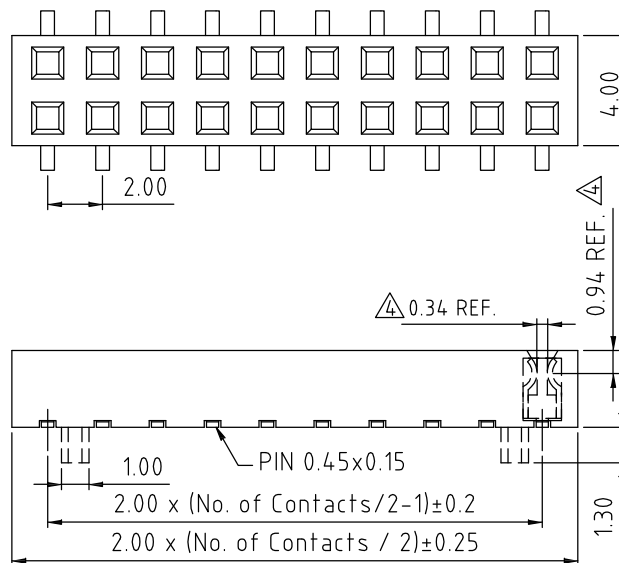
CURRENT RATING	2 AMP
INSULATOR RESISTANCE	1000 MEGOHMS MIN.
CONTACT RESISTANCE	20m ohms MAX.
DIELECTRIC WITHSTANDING	AC 500 V
OPERATING TEMPREATURE	-40°C TO +105°C
CONTACT MATERIAL	PHOSPHOR BRONZE
INSULATOR MATERIAL	THERMOPLASTIC, UL 94V-0
	STANDARD NYLON 6T
PLATING	GOLD, TIN, OR SELECTIVE OVER 30-50U" NICKEL
SOLDERABILITY	IR REFLOW: 260°C FOR 10 SEC
	MANUAL SOLDER: 350°C FOR 3-5 SEC

NOTES:

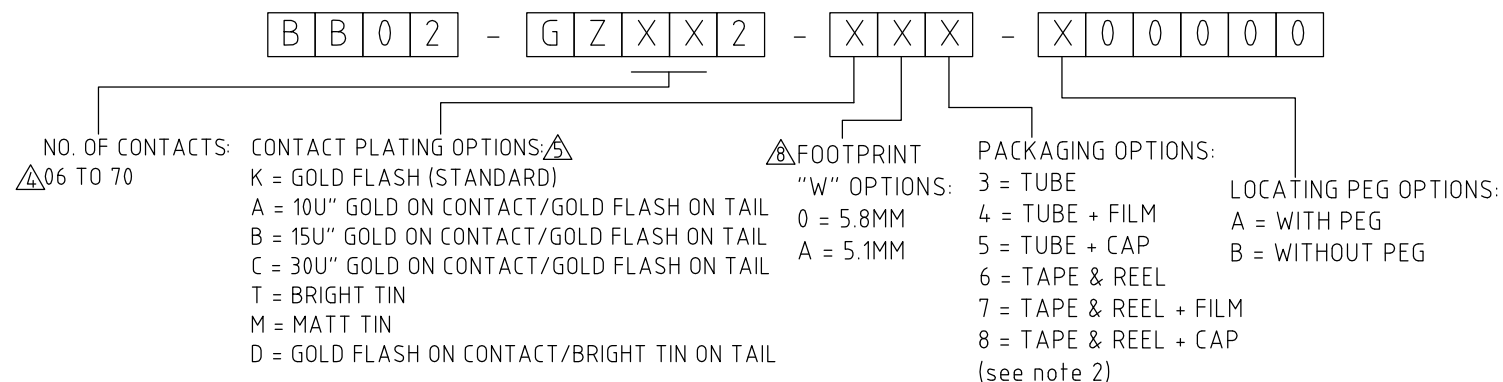
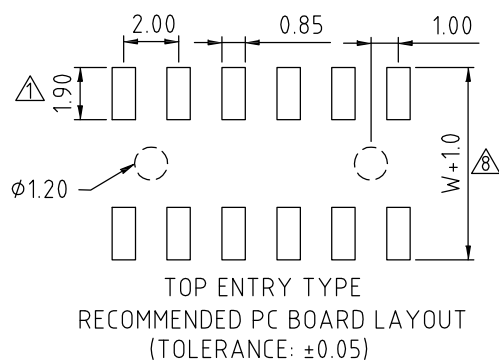
1. RECOMMENDED MATING PIN LENGTH: FOR TOP ENTRY: 2.0MM. 
2. PARTS WITH SMALLER NUMBER OF CONTACTS MIGHT BE PACKED IN BOX INSTEAD OF IN TUBE.

MATES WITH:

BB02-FA	BB02-FZ
BB02-FD	BB02-RH
BB02-FE	BB02-RN
BB02-FG	BB02-2F
BB02-FU	BB02-4F



HOW TO ORDER



REV	DATE	DESCRIPTION	Scale: 5:1	THIRD ANGLE	Unstated Tolerances: X: ± 0.30 -X: ± 0.25 XX: ± 0.15 XXX: ± 0.10	Material SEE NOTE	 Infratron www.infratron.de	Type: BB02-GZ
1	12/05/05	NEW RELEASE	Drawn: CHC					BB02-GZ
2	08/04/06	NEW AMEND PCB LAYOUT	App'd: XXXX	Title SOCKET		NOT TO SCALE		Drawing Number:
3	31/03/06	CHC AMEND TEMPERATURE	Date: 7 MAR. '14	Revision: 2.0	Unit: mm			Sheet 1 of 1
4	30/05/07	NEW DRAWING MODIFICATION						Drawing © E and O E
5	24/09/07	CHC REMOVE SELECTIVE GOLD						
6	03/06/08	CHC CONTACT PLATING						
7	05/07/09	CHC DRAWING MODIFICATION						
8	01/05/09	CHC DRAWING MODIFICATION						
9	30/10/13	NEW ADD FOOTPRINT A OPTION						
10	07/03/14	NEW AMEND MATING P/N						